

F

E

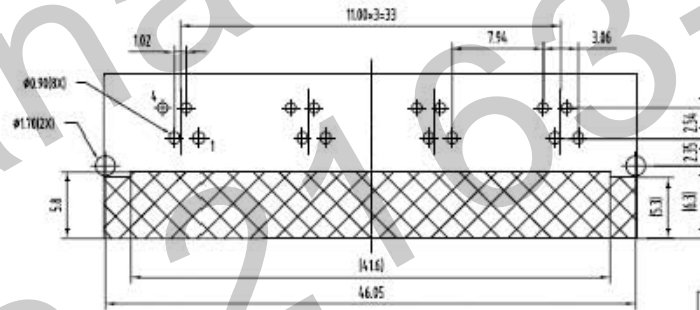
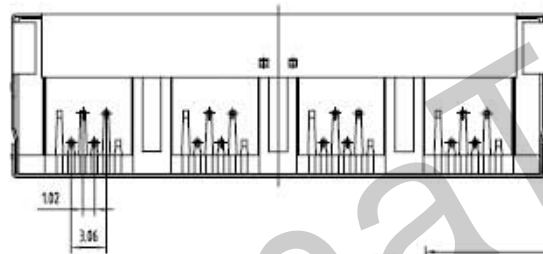
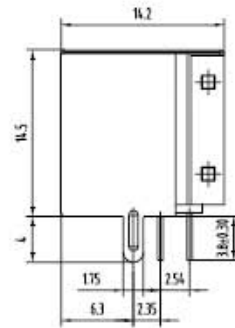
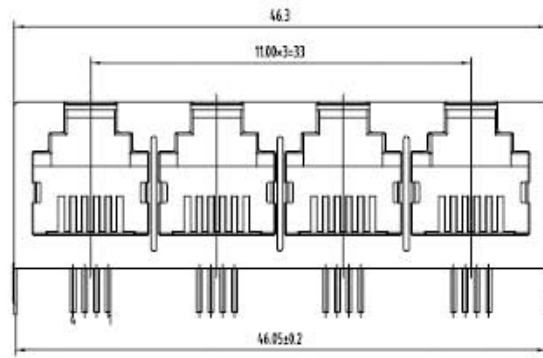
D

C

B

A

1 2 3 4 5 6 7 8



PC Board Layout

更改 REV	变更内容 MODIFICATION	日期 DATE	制图 DRAW	审核 APPROVE
A	图面发行	2012/10/29	JDL	Oscar

NOTES:

MATERIAL:

- 1.HOUSING MATERIAL :GLASS FILLED POLYESTER(UL94V-0).
- 2.CONTACT MATERIAL :PHOSPHOR BRONZE T=0.35mm.
- 3.PLATING :GOLD PLATING OVER NICKEL.
- 4.SHIELD :COPPER ALLOY 0.20mm THICKNESS PLATING NI.

ELECTRICAL:

- 1.VOLTAGE RATING :125 VAC RMS.
- 2.CURRENT RATING :1.5 AMP.
- 3.CONTACT RESISTANCE :50 MILLIOHMS MAX.
- 4.INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC.
- 5.DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

- 1.DURRABILITY :750 CYCLES MIN.
- 2.PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:

- 1.STORAGE : -40°C TO +85°C.
 2. OPERATION : 0°C TO 70°C.
- MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68,SUBPART F.

RoHS
2002/95/EC

QC : inspection item Cpk/Cpk and SPC Control item	DIMENSION IN mm [Inch]		HDC 有限公司	
	TOLERANCE UNLESS OTHERWISE SPECIFIED		图号 FILE NO.	图号 DWG NO. GRJJ-H7243
	.X± 0.20	X."± 1"	名称 TITLE: 5521 1X4 6P4C PCB JACK WITH SHIELDED SIDE ENTRY,ROUND PIN	
	.XX± 0.15	.X"± 0.5"		
.XXX± 0.075		制图 DRAW Oscar	审核 PROJ. 1/1	数量 SHEET 1/1
核准 APPROVE	检查 CHECK	比例 SCALE 1:1	图幅 SIZE A3	页次 REV A

1 2 3 4 5 6 7 8